**ISSP2017**

 **Exhibit APPLICATION form**

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| --- | --- |
| Company Name |  |
| Address |  |
| Name of corresponding personLast nameMiddle nameFirst name | PhoneFaxE-mail |
| Application Date | Exhibit Fee per Unit\120,000 |
|
| Number of Units for Exhibition(1unit=1panel and 1 table)\_\_\_\_\_\_\_\_ Units |
| AC100V-2A Power Supply (please check) 🞎 use 🞎 don’t useFree advertisement page on the proceedings and on the programs 🞎 yes 🞎 noLink to your homepage from ISSP2017 website 🞎 yes 🞎 noYour URL\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_**(Please attach your banner image file)**CM presentation by Powerpoint automatic slide 🞎 yes 🞎 no |
|
| Total Fee \ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ |
| Remarks |

**Application dead line is May 15, 2017**

**Application form (only this page) is to be sent to the following address via Email.**

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